



SIC SCHOTTKY DIODE TYPE 10A

• Suitable for high power application

650 V

34A/10A

Features

- Low conduction and switching loss
- · Zero reverse recovery
- High surge current capability
- Positive temperature coefficient device
- RoHS compliant and halogen free
- Temperature independent switching behavior

Benefits

- Increase parallel device convenience
- Enable high temperature application
- Realize compact and lightweight systems
- Allow high frequency operation
- Higher system efficiency
- · High reliability

• VDC

• **|**F (Tc=25 / 158 °C)

Applications

- · Switching mode power supply
- PFC
- UPS

- Motor drives
- Flywheel diode in power inverters
- · Solar/Wind renewable energy

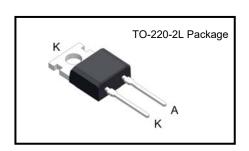
Maximum Ratings

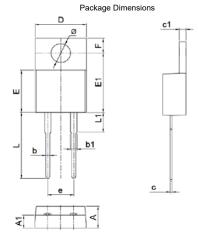
Operating Junction Temperature : -55°C to +175°C

Storage Temperature : -55 °C to +150 °C

Part Number	Maximum Recurrent Peak Reverse Voltage	Maximum DC Blocking Voltage
CSR010-065C3	650V	650V

Maximum Rating	Symbol	Conditions	Value	Unit
Repetitive peak reverse voltage	V_{RRM}	T _J =25 °C	650	V
		T _C =25 °C	34	
Continuous forward current	I _F	T _C =125 °C	20	А
		T _C =158°C	10	
Non-repetitive forward surge current	I _{FSM}	T _C =25 °C	80	
Power Dissipation	P _D	T _C =25 °C	93	W







Unit : mm

Symbol	Min	Max		
Α	4.30	4.70		
A1	2.52	2.82		
b	0.71	0.91		
b1	1.17	1.37		
С	0.30	0.50		
c1	1.17	1.37		
D	9.90	10.20		
Е	8.50	8.90		
E1	12.00	12.50		
е	4.88	5.26		
F	2.60	2.80		
L	13.00	14.00		
L1	3.80	4.20		
Ф	3.75	3.95		



Electrical Characteristics, at T_C =25 °C, unless otherwise specified.

Static Characteristics	Symbol	Conditions	Values			
			min.	typ.	max.	Unit
DC blocking voltage	V_{DC}		650	-	-	
Diode forward voltage	V _F	I _F =10A, T _C =25°C	-	1.3	1.5	V
		I _F =10A, T _C =175°C	-	1.5	-	
Reverse current	I _R	V _R =650V, T _C =25°C	-	5	50	μ Α
		V _R =650V, T _C =175°C	-	38	200	

AC Characteristics

Static Characteristics	Symbol	Conditions	Values			
			min.	typ.	max.	Unit
Total capacitive charge	Q _C	V _R =400V	-	27	-	nC
Total capacitance	С	V _R =0V, f=1 MHz	-	561	-	- pF
		V _R =400V, f=1 MHz	-	43	-	

Thermal Characteristics

Static Characteristics	Cumbal	Values	Unit	
Static Characteristics	Symbol	typ.		
Thermal resistance from junction to case	$R_{ hetaJC}$	1.6	°C/W	



Typical Device Performance

Fig.1 Typical Forward Characteristics

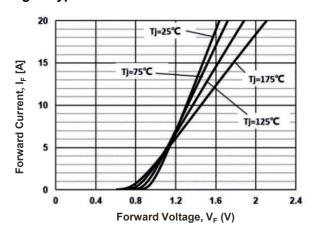


Fig.3 Typical Junction Capacitance vs. Reverse Voltage

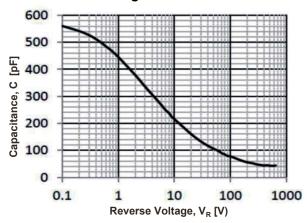


Fig.5 Typical Reverse Charge as Function of Reverse Voltage

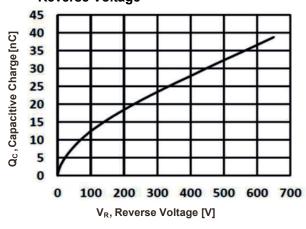


Fig.2 Typical Reverse Characteristics

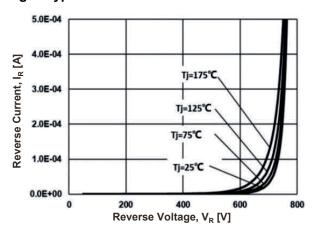


Fig.4 Diode Forward Current as Function of Temperature

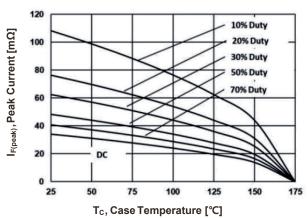
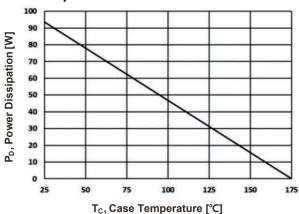


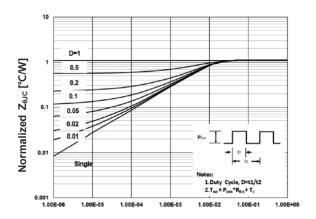
Fig.6 Power Dissipation as Function of Case Temperature





Typical Device Performance

Fig.7 Transient Thermal impedance



t_P, Rectangular Pulse Duration [sec]



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